# **IPC-4554** with Amendment 1 **2012 - January Specification for Immersion Tin Plating for Printed Circuit Boards** Supersedes IPC-4554 January 2007 A standard developed by IPC

Association Connecting Electronics Industries



# The Principles of Standardization

In May 1995 the IPC's Technical Activities Executive Committee (TAEC) adopted Principles of Standardization as a guiding principle of IPC's standardization efforts.

### **Standards Should:**

- Show relationship to Design for Manufacturability (DFM) and Design for the Environment (DFE)
- · Minimize time to market
- Contain simple (simplified) language
- Just include spec information
- Focus on end product performance
- Include a feedback system on use and problems for future improvement

### **Standards Should Not:**

- Inhibit innovation
- Increase time-to-market
- Keep people out
- Increase cycle time
- Tell you how to make something
- Contain anything that cannot be defended with data

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Adopted October 6, 1998

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# IPC-4554 with Amendment 1

# Specification for Immersion Tin Plating for Printed Circuit Boards

Developed by the Plating Processes Subcommittee (4-14) of the Fabrication Processes Committee (4-10) of IPC

## Supersedes:

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Users of this publication are encouraged to participate in the development of future revisions.

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